IDH08S60C

## $2^{\text {nd }}$ Generation thinQ! ${ }^{\text {TM }}$ SiC Schottky Diode

## Features

- Revolutionary semiconductor material - Silicon Carbide
- Switching behavior benchmark
- No reverse recovery/ No forward recovery
- No temperature influence on the switching behavior
- High surge current capability
- Pb-free lead plating; RoHS compliant
- Qualified according to JEDEC ${ }^{11}$ for target applications
- Breakdown voltage tested at $5 \mathrm{~mA}^{2)}$


## Product Summary

| $V_{\mathrm{DC}}$ | 600 | V |
| :--- | :---: | :--- |
| $Q_{\mathrm{C}}$ | 19 | nC |
| $I_{\mathrm{F}}$ | 8 | A |

PG-T0220-2

thinQ! 2G Diode specially designed for fast switching applications like:

- CCM PFC
- Motor Drives

| Type | Package | Marking | Pin 1 | Pin 2 |
| :--- | :--- | :--- | :--- | :--- |
| IDH08S60C | PG-TO220-2 | D08S60C | C | A |

Maximum ratings, at $T_{\mathrm{j}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Continuous forward current | $I_{\text {F }}$ | $T_{C}<140^{\circ} \mathrm{C}$ | 8 | A |
| RMS forward current | $I_{\text {F,RMS }}$ | $f=50 \mathrm{~Hz}$ | 12 |  |
| Surge non-repetitive forward current, sine halfwave | $I_{\text {F,SM }}$ | $T_{\mathrm{C}}=25^{\circ} \mathrm{C}, t_{\mathrm{p}}=10 \mathrm{~ms}$ | 59 |  |
| Repetitive peak forward current | $I_{\text {F,RM }}$ | $\begin{aligned} & T_{\mathrm{j}}=150^{\circ} \mathrm{C}, \\ & T_{\mathrm{C}}=100^{\circ} \mathrm{C}, D=0.1 \end{aligned}$ | 32 |  |
| Non-repetitive peak forward current | $I_{\text {F, max }}$ | $T_{\mathrm{C}}=25^{\circ} \mathrm{C}, t_{\mathrm{p}}=10 \mu \mathrm{~s}$ | 264 |  |
| $i^{2} t$ value | $\int i^{2} \mathrm{~d} t$ | $T_{\mathrm{C}}=25^{\circ} \mathrm{C}, t_{\mathrm{p}}=10 \mathrm{~ms}$ | 17 | $A^{2} s$ |
| Repetitive peak reverse voltage | $V_{\text {RRM }}$ |  | 600 | V |
| Diode dv/dt ruggedness | $\mathrm{d} v / \mathrm{d} t$ | $V_{\mathrm{R}}=0 \ldots .480 \mathrm{~V}$ | 50 | $\mathrm{V} / \mathrm{ns}$ |
| Power dissipation | $P_{\text {tot }}$ | $T_{C}=25^{\circ} \mathrm{C}$ | 75 | W |
| Operating and storage temperature | $T_{\mathrm{j}}, T_{\text {stg }}$ |  | -55 ... 175 | ${ }^{\circ} \mathrm{C}$ |
| Mounting torque |  | M3 and M3.5 screws | 60 | Mcm |
| Soldering temperature, wavesoldering only allowed at leads | $T_{\text {sold }}$ | $\begin{aligned} & 1.6 \mathrm{~mm}(0.063 \mathrm{in} .) \text { from } \\ & \text { case for } 10 \mathrm{~s} \end{aligned}$ | 260 | ${ }^{\circ} \mathrm{C}$ |

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| Parameter | Symbol | Conditions | Values |  |  | Unit |
| :--- | :---: | :--- | :--- | :--- | :--- | :--- |
|  |  |  | min. | typ. | max. |  |

## Thermal characteristics

| Thermal resistance, junction - case | $R_{\text {thJc }}$ |  | - | - | 2 | $\mathrm{~K} / \mathrm{W}$ |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| Thermal resistance, <br> junction - ambient | $R_{\text {thJA }}$ | leaded | - | - | 62 |  |

Electrical characteristics, at $T_{\mathrm{j}}=25^{\circ} \mathrm{C}$, unless otherwise specified

## Static characteristics

| DC blocking voltage | $V_{D C}$ | $I_{\mathrm{R}}=0.1 \mathrm{~mA}$ | 600 | - | - | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Diode forward voltage | $V_{F}$ | $I_{\text {F }}=8 \mathrm{~A}, T_{\mathrm{j}}=25^{\circ} \mathrm{C}$ | - | 1.5 | 1.7 |  |
|  |  | $I_{\mathrm{F}}=8 \mathrm{~A}, T_{\mathrm{j}}=150^{\circ} \mathrm{C}$ | - | 1.7 | 2.1 |  |
| Reverse current | $I_{\text {R }}$ | $V_{\mathrm{R}}=600 \mathrm{~V}, T_{\mathrm{j}}=25^{\circ} \mathrm{C}$ | - | 1 | 100 | $\mu \mathrm{A}$ |
|  |  | $V_{\mathrm{R}}=600 \mathrm{~V}, T_{\mathrm{j}}=150^{\circ} \mathrm{C}$ | - | 4 | 1000 |  |

## AC characteristics

| Total capacitive charge | $Q_{\text {c }}$ | $\begin{aligned} & V_{\mathrm{R}}=400 \mathrm{~V}, I_{\mathrm{F}} \leq I_{\mathrm{F}, \text { max }}, \\ & \mathrm{d} i_{\mathrm{F}} / \mathrm{d} t=200 \mathrm{~A} / \mathrm{\mu s}, \\ & T_{\mathrm{j}}=150^{\circ} \mathrm{C} \end{aligned}$ | - | 19 | - | nC |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Switching time ${ }^{3)}$ | $t_{c}$ |  | - | - | <10 | ns |
| Total capacitance | c | $V_{\mathrm{R}}=1 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | - | 310 | - | pF |
|  |  | $V_{\mathrm{R}}=300 \mathrm{~V}, f=1 \mathrm{MHz}$ | - | 50 | - |  |
|  |  | $\mathrm{V}_{\mathrm{R}}=600 \mathrm{~V}, f=1 \mathrm{MHz}$ | - | 50 |  |  |

## 1) J-STD20 and JESD22

${ }^{2)}$ All devices tested under avalanche conditions, for a time periode of 5 ms , at 5 mA .
${ }^{3)} \mathrm{t}_{\mathrm{c}}$ is the time constant for the capacitive displacement current waveform (independent from $\mathrm{T}_{\mathrm{j}}, \mathrm{I}_{\text {LOAD }}$ and di/dt), different from $\mathrm{t}_{\mathrm{rr}}$ which is dependent on $\mathrm{T}_{\mathrm{j}}$, $\mathrm{L}_{\text {LOAD }}$ and di/dt. No reverse recovery time constant $\mathrm{t}_{\mathrm{rr}}$ due to absence of minority carrier injection.
${ }^{4)}$ Only capacitive charge occuring, guaranteed by design

## 1 Power dissipation

$P_{\text {tot }}=\mathrm{f}\left(T_{\mathrm{C}}\right)$
parameter: $\mathrm{R}_{\mathrm{thJC}(\max )}$


3 Typ. forward characteristic
$I_{\mathrm{F}}=\mathrm{f}\left(V_{\mathrm{F}}\right) ; t_{\mathrm{p}}=400 \mu \mathrm{~s}$
parameter: $T_{\mathrm{j}}$


## 2 Diode forward current

$I_{\mathrm{F}}=\mathrm{f}\left(T_{\mathrm{C}}\right) ; T_{\mathrm{j}} \leq 175{ }^{\circ} \mathrm{C}$
parameter: $R_{\mathrm{thJC}(\text { max })} ; V_{\mathrm{F}(\text { max })}$


4 Typ. forward characteristic in surge current mode
$I_{\mathrm{F}}=\mathrm{f}\left(V_{\mathrm{F}}\right) ; t_{\mathrm{p}}=400 \mu \mathrm{~s}$; parameter: $T_{\mathrm{j}}$


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5 Typ. forward power dissipation vs.

## average forward current

$P_{\mathrm{F}, \mathrm{AV}}=\mathrm{f}\left(I_{\mathrm{F}}\right), T_{\mathrm{C}}=100^{\circ} \mathrm{C}$, parameter: $D=t_{\mathrm{p}} / T$


7 Transient thermal impedance
$Z_{\text {thJC }}=f\left(t_{p}\right)$
parameter: $D=t_{\mathrm{p}} / T$


6 Typ. reverse current vs. reverse voltage
$I_{\mathrm{R}}=\mathrm{f}\left(V_{\mathrm{R}}\right)$
parameter: $T_{\mathrm{j}}$


8 Typ. capacitance vs. reverse voltage
$C=\mathrm{f}\left(V_{\mathrm{R}}\right) ; T_{\mathrm{C}}=25^{\circ} \mathrm{C}, f=1 \mathrm{MHz}$


9 Typ. C stored energy
$E_{C}=f\left(V_{R}\right)$
10 Typ. capacitance charge vs. current slope
$Q_{C}=f\left(\mathrm{~d} i_{\mathrm{F}} / \mathrm{d} t\right)^{4} ; T_{\mathrm{j}}=150^{\circ} \mathrm{C} ; I_{\mathrm{F}} \leq I_{\mathrm{F}, \text { max }}$



PG-TO220-2: Outline


Dimensions in mm/inches

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Infineon Technologies AG
81726 Munich, Germany
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